
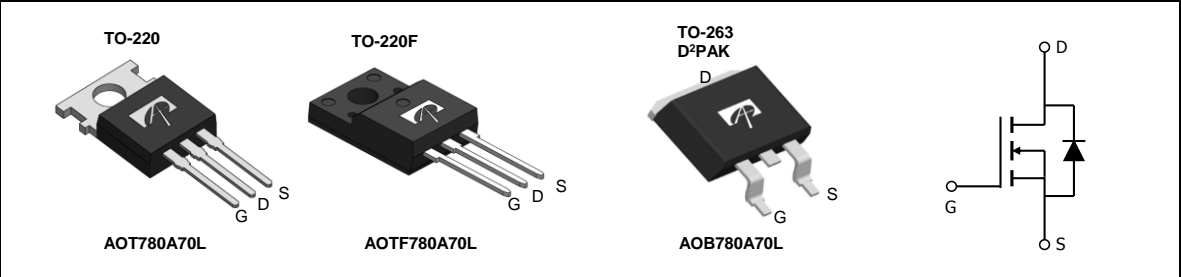


General Description <ul style="list-style-type: none"> Proprietary αMOS5™ technology Low $R_{DS(ON)}$ Optimized switching parameters for better EMI performance Enhanced body diode for robustness and fast reverse recovery Applications <ul style="list-style-type: none"> PFC and PWM stages (Flyback, LLC) of Adapter, PC Silverbox, Server, Gaming Power Supply, Industrial, TV, Lighting 	Product Summary <table border="0"> <tr> <td>$V_{DS} @ T_{j,max}$</td> <td>800V</td> </tr> <tr> <td>I_{DM}</td> <td>28A</td> </tr> <tr> <td>$R_{DS(ON),max}$</td> <td>< 0.78Ω</td> </tr> <tr> <td>$Q_{g,typ}$</td> <td>11.5nC</td> </tr> <tr> <td>$E_{oss} @ 400V$</td> <td>1.4μJ</td> </tr> </table> 100% UIS Tested 100% R_g Tested <div style="text-align: right;">  </div>	$V_{DS} @ T_{j,max}$	800V	I_{DM}	28A	$R_{DS(ON),max}$	< 0.78 Ω	$Q_{g,typ}$	11.5nC	$E_{oss} @ 400V$	1.4 μ J
$V_{DS} @ T_{j,max}$	800V										
I_{DM}	28A										
$R_{DS(ON),max}$	< 0.78 Ω										
$Q_{g,typ}$	11.5nC										
$E_{oss} @ 400V$	1.4 μ J										



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOTF780A70L	TO220F	Tube	1000
AOT780A70L	TO220	Tube	1000
AOB780A70L	TO263	Tape&Reel	800

Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted				
Parameter	Symbol	AOT(B)780A70L	AOTF780A70L	Units
Drain-Source Voltage	V_{DS}	700		V
Gate-Source Voltage	V_{GS}	± 20		V
Gate-Source Voltage (dynamic) AC($f > 1\text{Hz}$)	V_{GS}	± 30		V
Continuous Drain Current	I_D	$T_C=25^\circ\text{C}$	7	7*
		$T_C=100^\circ\text{C}$	4.5	4.5*
Pulsed Drain Current ^C	I_{DM}	28		A
Avalanche Current ^C $L=1\text{mH}$	I_{AR}	1.7		A
Repetitive avalanche energy ^C	E_{AR}	1.5		mJ
Single pulsed avalanche energy ^G	E_{AS}	11		mJ
MOSFET dv/dt ruggedness	dv/dt	100		V/ns
Peak diode recovery dv/dt		20		
Power Dissipation ^B	P_D	$T_C=25^\circ\text{C}$	89	25
		Derate above 25°C	0.7	0.2
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150		$^\circ\text{C}$
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	T_L	300		$^\circ\text{C}$

Thermal Characteristics				
Parameter	Symbol	AOT(B)780A70L	AOTF780A70L	Units
Maximum Junction-to-Ambient ^{A,D}	$R_{\theta JA}$	65	65	$^\circ\text{C/W}$
Maximum Case-to-sink ^A	$R_{\theta CS}$	0.5	--	$^\circ\text{C/W}$
Maximum Junction-to-Case	$R_{\theta JC}$	1.4	5.0	$^\circ\text{C/W}$

* Drain current limited by maximum junction temperature.

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
STATIC PARAMETERS							
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V, T _J =25°C	700			V	
		I _D =250μA, V _{GS} =0V, T _J =150°C		800			
BV _{DSS} /ΔT _J	Breakdown Voltage Temperature Coefficient	I _D =250μA, V _{GS} =0V		0.56		V/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =700V, V _{GS} =0V			1	μA	
		V _{DS} =560V, T _J =125°C			10		
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V			±100	nA	
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =5V, I _D =250μA	2.9	3.5	4.1	V	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =1.4A		0.7	0.78	Ω	
g _{FS}	Forward Transconductance	V _{DS} =10V, I _D =1.4A		3		S	
V _{SD}	Diode Forward Voltage	I _S =1.4A, V _{GS} =0V		0.8	1.2	V	
I _S	Maximum Body-Diode Continuous Current				7	A	
I _{SM}	Maximum Body-Diode Pulsed Current ^C				28	A	
DYNAMIC PARAMETERS							
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz		675		pF	
C _{oss}	Output Capacitance				18		pF
C _{o(er)}	Effective output capacitance, energy related ^H	V _{GS} =0V, V _{DS} =0 to 400V, f=1MHz		16.5		pF	
C _{o(tr)}	Effective output capacitance, time related ^I				72		pF
C _{rss}	Reverse Transfer Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz		1.8		pF	
R _g	Gate resistance	f=1MHz		3.1		Ω	
SWITCHING PARAMETERS							
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =480V, I _D =3.5A		11.5		nC	
Q _{gs}	Gate Source Charge				4.8		nC
Q _{gd}	Gate Drain Charge				2.8		nC
T _{d(on)}	Turn-On DelayTime	V _{GS} =10V, V _{DS} =400V, I _D =3.5A, R _G =5Ω		18		ns	
T _r	Turn-On Rise Time				9		ns
T _{d(off)}	Turn-Off DelayTime				30		ns
T _f	Turn-Off Fall Time				12		ns
T _{rr}	Body Diode Reverse Recovery Time				230		ns
I _{rm}	Peak Reverse Recovery Current	I _F =3.5A, di/dt=100A/μs, V _{DS} =400V		16.5		A	
Q _{rr}	Body Diode Reverse Recovery Charge			2.5		μC	

A. The value of R_{θJA} is measured with the device in a still air environment with T_A=25° C.

B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C, Ratings are based on low frequency and duty cycles to keep initial T_J=25° C.

D. The R_{θJA} is the sum of the thermal impedance from junction to case R_{θJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

G. L=60mH, I_{AS}=0.6A, R_G=25Ω, Starting T_J=25° C.

H. C_{o(er)} is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

I. C_{o(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

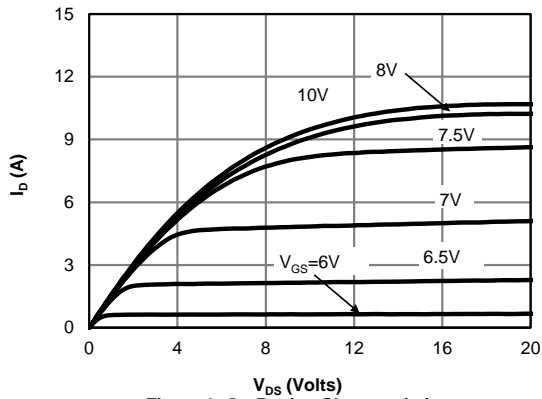


Figure 1: On-Region Characteristics

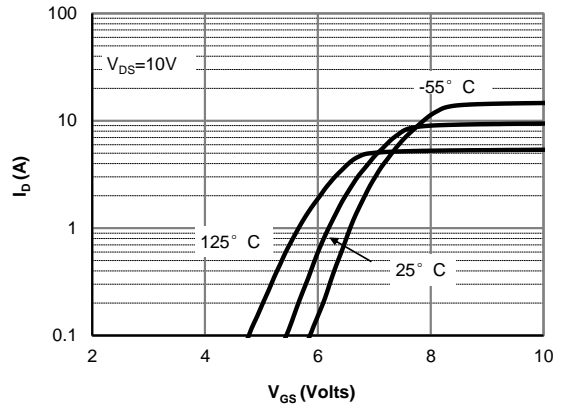


Figure 2: Transfer Characteristics

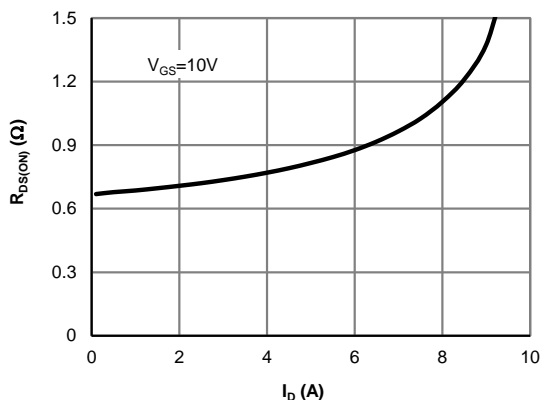


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

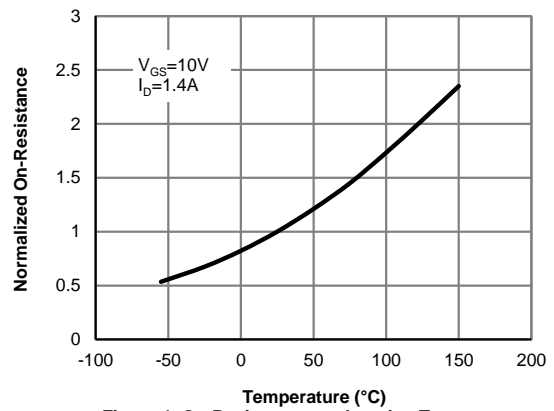


Figure 4: On-Resistance vs. Junction Temperature

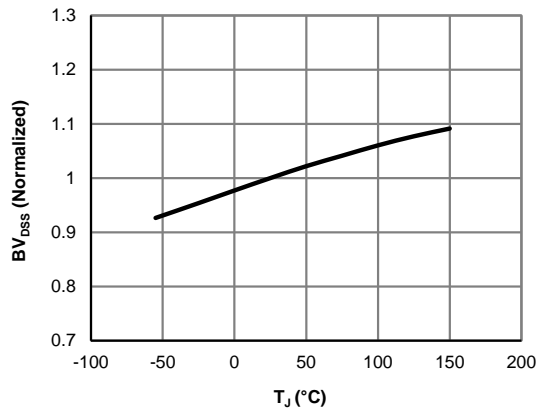


Figure 5: Break Down vs. Junction Temperature

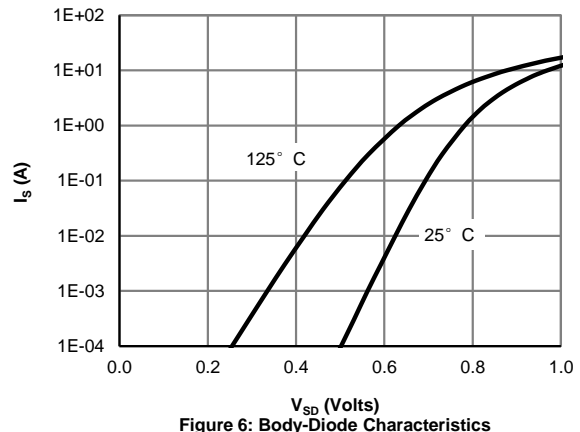


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

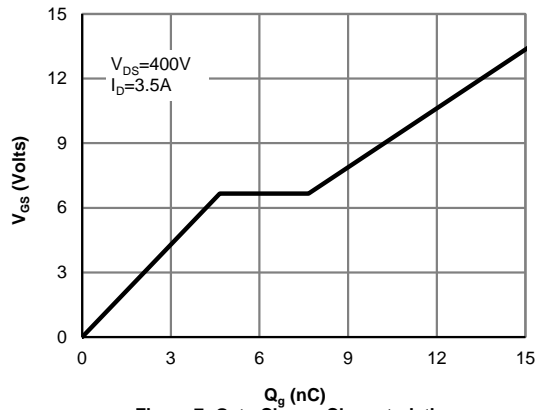


Figure 7: Gate-Charge Characteristics

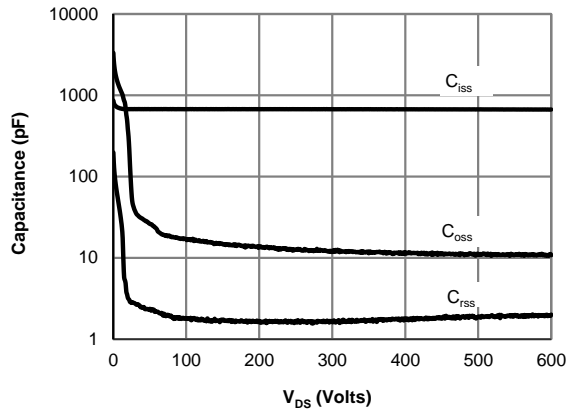


Figure 8: Capacitance Characteristics

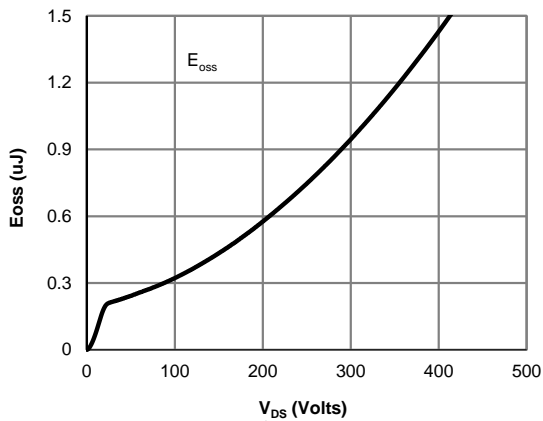


Figure 9: Coss stored Energy

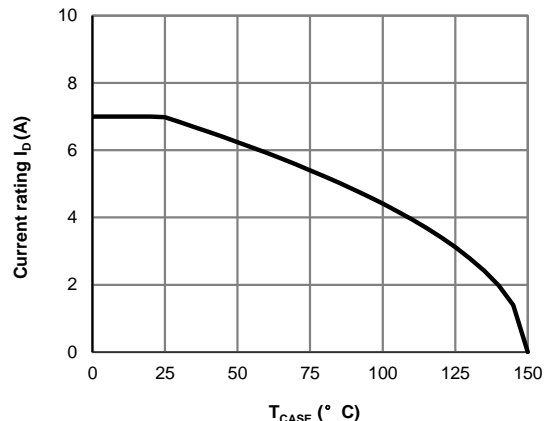


Figure 10: Current De-rating (Note F)

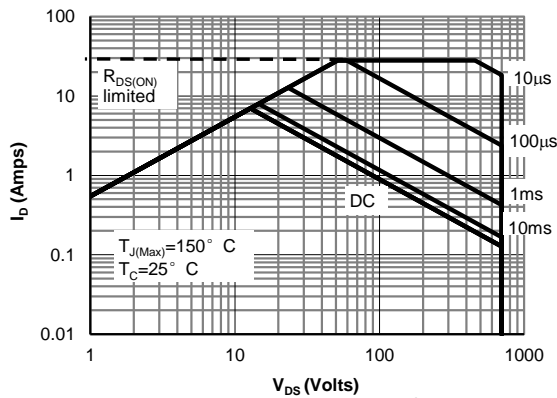


Figure 11: Maximum Forward Biased Safe Operating Area for AOT(B)780A70L (Note F)

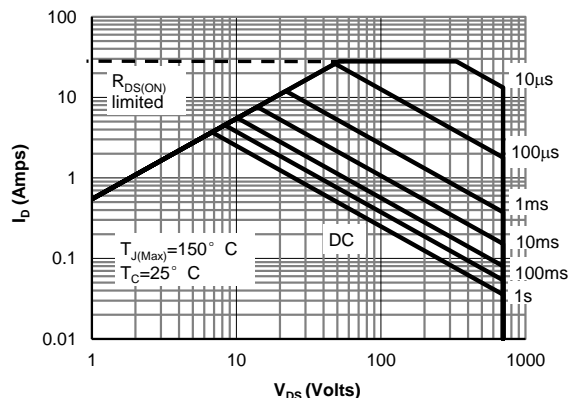


Figure 12: Maximum Forward Biased Safe Operating Area for AOTF780A70L (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

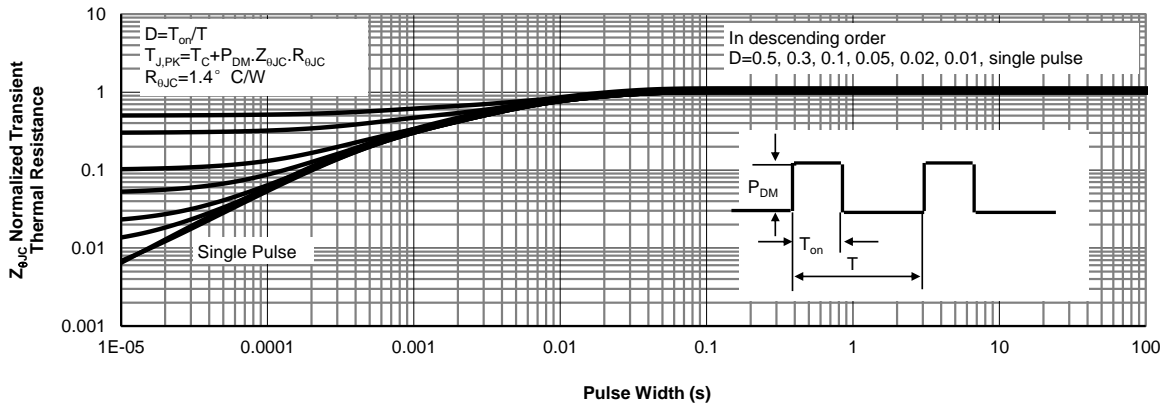


Figure 13: Normalized Maximum Transient Thermal Impedance for AOT(B)780A70L (Note F)

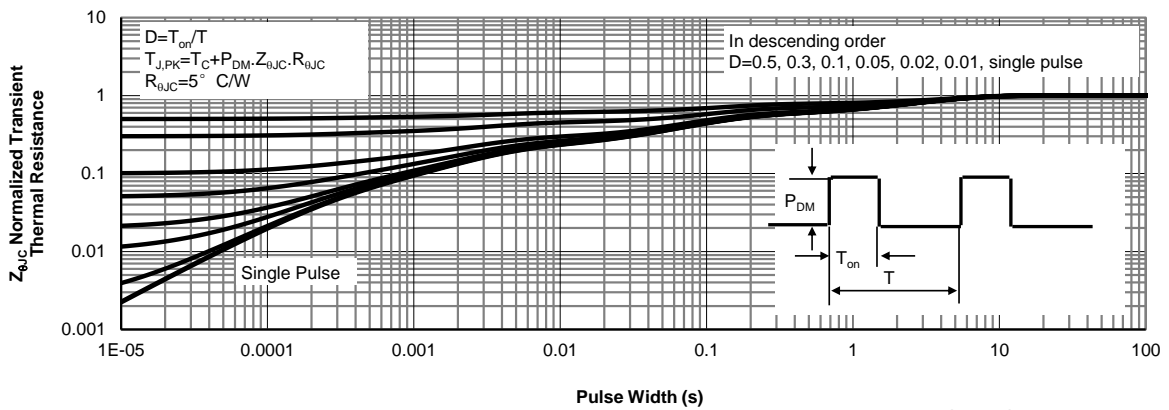
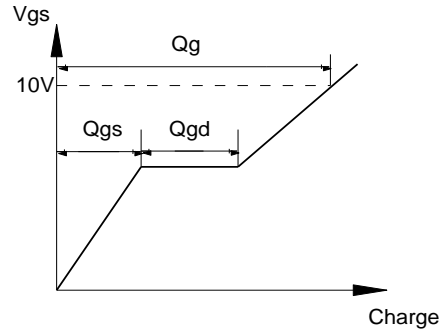
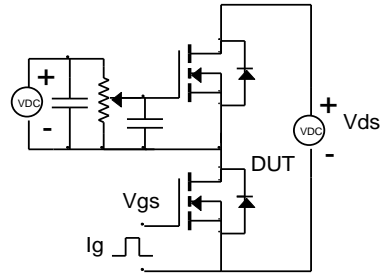
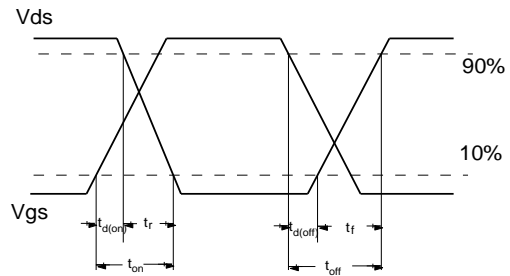
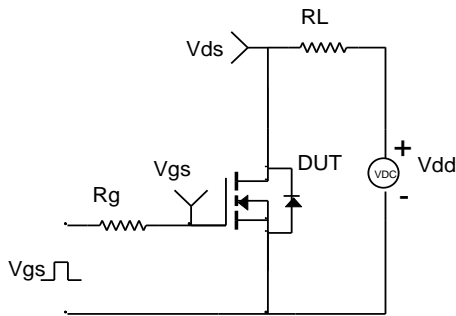


Figure 14: Normalized Maximum Transient Thermal Impedance for AOTF780A70L (Note F)

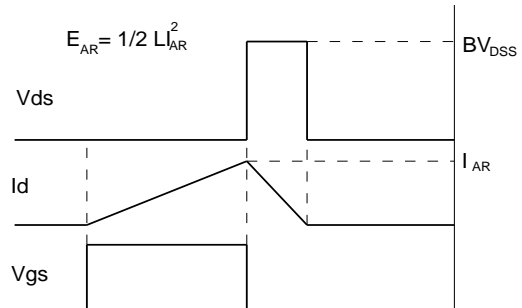
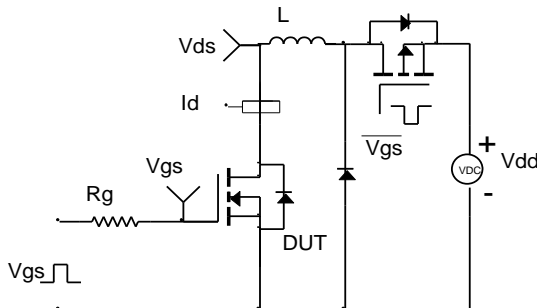
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

